# DUAL 15- $\Omega$ SPDT ANALOG SWITCH 

Check for Samples: TS5A23157-Q1

## FEATURES

- Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
- Device Temperature Grade 1: $-40^{\circ} \mathrm{C}$ to 125응
- Device HBM ESD Classification Level H2
- Device CDM ESD Classification Level C4B
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- Specified Break-Before-Make Switching
- Low ON-State Resistance (15 $\Omega$ )
- Control Inputs Are 5-V Tolerant
- Low Charge Injection
- Excellent ON-Resistance Matching
- Low Total Harmonic Distortion
- 1.8-V to $5.5-\mathrm{V}$ Single-Supply Operation


## APPLICATIONS

- Sample-and-Hold Circuits
- Battery-Powered Equipment
- Audio and Video Signal Routing
- Communication Circuits



## DESCRIPTION

The TS5A23157 is a dual, single-pole, double-throw (SPDT) analog switch designed to operate from 1.65 V to 5.5 V. This device can handle both digital and analog signals. The device can transmit signals up to 5.5 V (peak) in either direction.

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.

Table 1. FUNCTION TABLE

| INPUT <br> IN | NC TO COM, <br> COM TO NC | NO TO COM, <br> COM TO NO |
| :---: | :---: | :---: |
| L | ON | OFF |
| H | OFF | ON |

Table 2. SUMMARY OF CHARACTERISTICS

| Configuration | 2:1 Multiplexer and <br> Demultiplexer <br> $(2 \times$ SPDT $)$ |
| :--- | :--- |
| Number of channels | 2 |
| $r_{\text {on }}$ | $15 \Omega$ |
| $\Delta r_{\text {on }}$ | $0.15 \Omega$ |
| $r_{\text {onfllat) }}$ | $4 \Omega$ |
| $\mathrm{t}_{\text {ON }}$ | 8.7 ns |
| toff | 6.8 ns |
| $\mathrm{t}_{\text {BBM }}$ | 0.5 ns |
| Charge injection | 7 pC |
| Bandwidth | 220 MHz |
| OFF isolation | -65 dB at 10 MHz |
| Crosstalk | -66 dB at 10 MHz |
| Total harmonic distortion | $0.01 \%$ |
| $I_{\text {Com(off) }} / l_{\text {NC(OFF) }}$ | $\pm 1 \mathrm{\mu A}$ |
| Package option | $10-\mathrm{pin} \mathrm{DGS}$ |

## Absolute Maximum Ratings ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Supply voltage range ${ }^{(2)}$ |  | -0.5 | 6.5 | V |
| $V_{\mathrm{NC}}$ <br> $\mathrm{V}_{\mathrm{NO}}$ <br> $\mathrm{V}_{\mathrm{COM}}$ | Analog voltage range ${ }^{(2)}{ }^{(3)(4)}$ |  | -0.5 | $\mathrm{V}_{+}+0.5$ | V |
| $\mathrm{I}_{\text {I/OK }}$ | Analog port diode current | $\mathrm{V}_{\mathrm{NC}}, \mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}<0$ or $\mathrm{V}_{\mathrm{NC}}, \mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}>\mathrm{V}_{+}$ |  | $\pm 50$ | mA |
| $I_{\mathrm{NC}}$ $\mathrm{I}_{\mathrm{NO}}$ $\mathrm{I}_{\mathrm{COM}}$ | On-state switch current | $\mathrm{V}_{\mathrm{NC}}, \mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}=0$ to $\mathrm{V}_{+}$ |  | $\pm 50$ | mA |
| $\mathrm{V}_{\text {IN }}$ | Digital input voltage range ${ }^{(2)(3)}$ |  | -0.5 | 6.5 | V |
| $\mathrm{I}_{\text {K }}$ | Digital input clamp current | $\mathrm{V}_{\text {IN }}<0$ |  | -50 | mA |
|  | Continuous current through $\mathrm{V}_{+}$or GND |  |  | $\pm 100$ | mA |
| $\theta_{\mathrm{JA}}$ | Package thermal impedance ${ }^{(5)}$ |  |  | 165.36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |
| ESD | Electrostatic discharge rating | Human-body model H2 |  | 2 | kV |
|  |  | Charged-device model C4B |  | 750 | V |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltages are with respect to ground, unless otherwise specified.
(3) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(4) This value is limited to 5.5 V maximum.
(5) The package thermal impedance is calculated in accordance with JESD 51-7.

## Electrical Characteristics for 5-V Supply

$\mathrm{V}_{+}=4.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | T ${ }_{\text {A }}$ | $\mathrm{V}_{+}$ | MIN | TYP ${ }^{(1)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}$, $\mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{NC}}$ |  |  |  |  | 0 |  | $\mathrm{V}_{+}$ | V |
| ON-state resistance | ron | $\begin{aligned} & 0 \leq \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}} \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-30 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | Full | 4.5 V | 15 |  |  | $\Omega$ |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=3.15 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-30 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 6 | $25^{\circ} \mathrm{C}$ | 4.5 V | 0.15 |  |  | $\Omega$ |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}} \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-30 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | 4 |  | $\Omega$ |
| NC, NO <br> OFF leakage current | $I_{\text {NC(OFF) }}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=0 \text { to } \mathrm{V}_{+}, \end{aligned}$ | Switch OFF, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 5.5 V | -1 | 0.05 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 |  | 1 |  |
| NC, NO ON leakage current | $I_{\mathrm{NC}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, See Figure 7 | $25^{\circ} \mathrm{C}$ | 5.5 V | -0.1 |  | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 |  | 1 |  |
| COM ON leakage current | $\mathrm{I}_{\text {Com(ON }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$, | Switch ON, See Figure 7 | $25^{\circ} \mathrm{C}$ | 5.5 V | -0.1 |  | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 |  | 1 |  |
| Digital Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | $\mathrm{V}_{+} \times 0.7$ |  |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  |  |  | $\times 0.3$ | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 5.5 V | -1 | 0.05 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 |  | 1 |  |

(1) $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
(2) Hold all unused digital inputs of the device at $\mathrm{V}+$ or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 5-V Supply (continued)

$\mathrm{V}_{+}=4.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP ${ }^{(1)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turnon time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{gathered} 4.5 \mathrm{~V} \\ \text { to } \\ 5.5 \mathrm{~V} \\ \hline \end{gathered}$ | 1.2 |  | 8.7 | ns |
| Turnoff time | toff | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{gathered} 4.5 \mathrm{~V} \\ \text { to } \\ 5.5 \mathrm{~V} \end{gathered}$ | 0.5 |  | 6.8 | ns |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} / 2, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF},$ <br> See Figure 10 | $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 4.5 \mathrm{~V} \\ & \text { to } \\ & 5.5 \mathrm{~V} \end{aligned}$ | 0.5 |  |  | ns |
| Charge injection | Qc | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} / 2, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | See Figure 14 | $25^{\circ} \mathrm{C}$ | 5 V |  | 7 |  | pC |
| NC, NO OFF capacitance | $\mathrm{C}_{\mathrm{NC} \text { (OFF) }}$, $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, | Switch OFF, See Figure 8 | $25^{\circ} \mathrm{C}$ | 5 V |  | 5.5 |  | pF |
| NC, NO ON capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{ON})}$, $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, | Switch ON, See Figure 8 | $25^{\circ} \mathrm{C}$ | 5 V |  | 17.5 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\text {COM }}=\mathrm{V}_{+}$or GND, | Switch ON, See Figure 8 | $25^{\circ} \mathrm{C}$ | 5 V |  | 17.5 |  | pF |
| Digital input capacitance | $\mathrm{C}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{+}$or GND, | See Figure 8 | $25^{\circ} \mathrm{C}$ | 5 V |  | 2.8 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON, See Figure 11 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | 220 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch OFF, See Figure 12 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | -65 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {taLk }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch ON, See Figure 13 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | -66 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & f=600 \mathrm{~Hz} \text { to } \\ & 20 \mathrm{kHz}, \\ & \text { See Figure } 15 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 4.5 V |  | 0.01 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 5.5 V |  |  | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 10 |  |
| Change in supply current | $\Delta I_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}-0.6 \mathrm{~V}$ |  | Full | 5.5 V |  |  | 500 | $\mu \mathrm{A}$ |

## Electrical Characteristics for 3.3-V Supply

$\mathrm{V}_{+}=3 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | V+ | MIN | TYP ${ }^{(1)} \quad$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {Com }}$, $\mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{NC}}$ |  |  |  |  |  | $\mathrm{V}_{+}$ | V |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & 0 \leq V_{N O} \text { or } V_{N C} \leq V_{+}, \\ & I_{C O M}=-24 m A, \end{aligned}$ | Switch ON, See Figure 6 | Full | 3 V | 23 |  | $\Omega$ |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=2.1 \mathrm{~V}$, <br> $I_{\text {сом }}=-24 \mathrm{~mA}$, | Switch ON, See Figure 6 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.2 | $\Omega$ |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq V_{N O} \text { or } V_{N C} \leq V_{+}, \\ & l_{\text {COM }}=-24 m A, \end{aligned}$ | Switch ON, See Figure 6 | $25^{\circ} \mathrm{C}$ | 3 V |  | 9 | $\Omega$ |
| NC, NO <br> OFF leakage current | $I_{\text {NC(OFF) }}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=0 \text { to } \mathrm{V}_{+}, \end{aligned}$ | Switch OFF, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 3.6 V | -1 | $0.05 \quad 1$ | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 3.6 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| COM <br> ON leakage current | $\mathrm{I}_{\text {COM(ON }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=$ Open, $\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$, | Switch ON, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 3.6 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Digital Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | $V_{+} \times 0.7$ |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  |  | $\mathrm{V}_{+} \times 0.3$ | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 3.6 V | -1 | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Dynamic |  |  |  |  |  |  |  |  |
| Turnon time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \\ & \hline \end{aligned}$ | Full | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ | 2.0 | 10.6 | ns |
| Turnoff time | $\mathrm{t}_{\text {OFF }}$ | $V_{\mathrm{NC}}=\mathrm{GND}$ and $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$, or <br> $\mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+}$and $\mathrm{V}_{\mathrm{NO}}=\mathrm{GND}$, | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \\ & \hline \end{aligned}$ | Full | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ | 1.0 | 8.3 | ns |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} / 2, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \text {, }$ <br> See Figure 10 | $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ | 0.5 |  | ns |
| Charge injection | Qc | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{CL}=0.1 \mathrm{nF}, \end{aligned}$ | See Figure 14 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 3 | pC |
| Bandwidth | BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \text { Switch ON, } \end{aligned}$ | See Figure 11 | $25^{\circ} \mathrm{C}$ | 3 V |  | 220 | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISo }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch OFF, <br> See Figure 12 | $25^{\circ} \mathrm{C}$ | 3 V |  | -65 | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch ON, See Figure 13 | $25^{\circ} \mathrm{C}$ | 3 V |  | -66 | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & f=600 \mathrm{~Hz} \text { to } \\ & 20 \mathrm{kHz}, \\ & \text { See Figure } 15 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.015 | \% |
| Supply |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{1 N}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 3.6 V |  | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  | 10 |  |
| Change in supply current | $\Delta I_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}-0.6 \mathrm{~V}$ |  | Full | 3.6 V |  | 500 | $\mu \mathrm{A}$ |

(1) $T_{A}=25^{\circ} \mathrm{C}$
(2) Hold all unused digital inputs of the device at $\mathrm{V}+$ or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 2.5-V Supply

$\mathrm{V}_{+}=2.3 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | V+ | MIN | TYP ${ }^{(1)} \quad$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{V}_{\mathrm{COM}}, \\ \mathrm{~V}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 | $\mathrm{V}_{+}$ | V |
| ON-state resistance | $\mathrm{r}_{\text {on }}$ | $\begin{aligned} & 0 \leq \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}} \leq \mathrm{V}_{+}, \\ & \mathrm{l}_{\mathrm{COM}}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | Full | 2.3 V | 50 |  | $\Omega$ |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.6 \mathrm{~V} \text {, }$ $\mathrm{I}_{\mathrm{COM}}=-8 \mathrm{~mA} \text {, }$ | Switch ON, <br> See Figure 6 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 0.5 | $\Omega$ |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}} \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 27 | $\Omega$ |
| NC, NO OFF leakage current | $\mathrm{I}_{\mathrm{NC} \text { (OFF) }}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=0 \text { to } \mathrm{V}_{+}, \end{aligned}$ | Switch OFF, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 2.7 V | -1 | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, See Figure 7 | $25^{\circ} \mathrm{C}$ | 2.7 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| COM <br> ON leakage current | $\mathrm{I}_{\text {COM (ON) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$, | Switch ON, See Figure 7 | $25^{\circ} \mathrm{C}$ | 2.7 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Digital Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | $V_{+} \times 0.7$ |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  |  | $\mathrm{V}_{+} \times 0.3$ | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 2.7 V | -1 | 0.051 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Dynamic |  |  |  |  |  |  |  |  |
| Turnon time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{aligned} & 2.3 \mathrm{~V} \\ & \text { to } \\ & 2.7 \mathrm{~V} \end{aligned}$ | 2.5 | 17 | ns |
| Turnoff time | $\mathrm{t}_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{gathered} 2.3 \mathrm{~V} \\ \text { to } \\ 2.7 \mathrm{~V} \\ \hline \end{gathered}$ | 1.5 | 10.5 | ns |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} / 2, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF},$ <br> See Figure 10 | $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 2.3 \mathrm{~V} \\ & \text { to } \\ & 2.7 \mathrm{~V} \end{aligned}$ | 0.5 |  | ns |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON, See Figure 11 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 220 | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch OFF, <br> See Figure 12 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | -65 | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch ON, <br> See Figure 13 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | -66 | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & f=600 \mathrm{~Hz} \text { to } \\ & 20 \mathrm{kHz}, \\ & \text { See Figure } 15 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 0.025 | \% |
| Supply |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 2.7 V |  | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  | 10 |  |
| Change in supply current | $\Delta l_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}-0.6 \mathrm{~V}$ |  | Full | 2.7 V |  | 500 | $\mu \mathrm{A}$ |

(1) $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
(2) Hold all unused digital inputs of the device at $\mathrm{V}+$ or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 1.8-V Supply

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP ${ }^{(1)}$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{V}_{\mathrm{COM}} \\ \mathrm{~V}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 | $V_{+}$ | V |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & 0 \leq \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}} \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-4 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | Full | 1.65 V |  | 180 | $\Omega$ |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.15 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-4 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 6 | $25^{\circ} \mathrm{C}$ | 1.65 V | 1 |  | $\Omega$ |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq V_{N O} \text { or } V_{N C} \leq V_{+}, \\ & I_{\mathrm{COM}}=-4 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 6 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 110 | $\Omega$ |
| NC, NO <br> OFF leakage current | $\mathrm{I}_{\mathrm{NC}(\mathrm{OFF})}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=0 \text { to } \mathrm{V}_{+}, \end{aligned}$ | Switch OFF, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 1.95 V | -1 | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}} \text { or } \mathrm{V}_{\mathrm{NO}}=0 \text { to } \mathrm{V}_{+}, \\ & \mathrm{V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, <br> See Figure 7 | $25^{\circ} \mathrm{C}$ | 1.95 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| COM <br> ON leakage current | $\mathrm{I}_{\text {com(on) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$, | Switch ON, See Figure 7 | $25^{\circ} \mathrm{C}$ | 1.95 V | -0.1 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Digital Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | $V_{+} \times 0.75$ |  | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  | $\mathrm{V}_{+} \times 0.25$ |  | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 1.95 V | -1 | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -1 | 1 |  |
| Dynamic |  |  |  |  |  |  |  |  |
| Turnon time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{gathered} 1.65 \mathrm{~V} \\ \text { to } \\ 1.95 \mathrm{~V} \end{gathered}$ | 5.5 | 27 | ns |
| Turnoff time | $\mathrm{t}_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{GND} \text { and } \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \text {or } \\ & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{+} \text {and } \mathrm{V}_{\mathrm{NO}}=\mathrm{GND}, \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ & \text { See Figure } 9 \end{aligned}$ | Full | $\begin{gathered} 1.65 \mathrm{~V} \\ \text { to } \\ 1.95 \mathrm{~V} \\ \hline \end{gathered}$ | 2 | 16 | ns |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} / 2, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $C_{L}=35 \mathrm{pF},$ <br> See Figure 10 | $25^{\circ} \mathrm{C}$ | $\begin{gathered} 1.65 \mathrm{~V} \\ \text { to } \\ 1.95 \mathrm{~V} \end{gathered}$ | 0.5 |  | ns |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON, See Figure 11 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 220 | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch OFF, <br> See Figure 12 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -60 | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=10 \mathrm{MHz}, \end{aligned}$ | Switch ON, See Figure 13 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -66 | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & \mathrm{f}=600 \mathrm{~Hz} \text { to } \\ & 20 \mathrm{kHz}, \\ & \text { See Figure } 15 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 0.015 | \% |
| Supply |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 1.95 V |  | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  | 10 |  |
| Change in supply current | $\Delta I_{+}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{+}-0.6 \mathrm{~V}$ |  | Full | 1.95 V |  | 500 | $\mu \mathrm{A}$ |

(1) $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
(2) Hold all unused digital inputs of the device at $\mathrm{V}+$ or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## TYPICAL CHARACTERISTICS



Figure 1. $\mathrm{r}_{\text {on }}$ versus $\mathrm{V}_{\text {com }}$


Figure 3. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}}$ versus Temperature $\left(V_{+}=5 \mathrm{~V}\right)$


Figure 2. $\mathrm{t}_{\mathrm{oN}}$ and $\mathrm{t}_{\text {off }}$ versus $\mathrm{V}_{+}$


Figure 4. Frequency Response $\left(\mathrm{V}_{+}=3 \mathrm{~V}\right)$


Figure 5. Total Harmonic Distortion (THD) versus Frequency ( $\mathrm{V}_{+}=3 \mathrm{~V}$ )

## PIN DESCRIPTION

| NAME | PIN NO. | DESCRIPTION |
| :---: | :---: | :--- |
| COM1 | 10 | Common |
| COM2 | 6 | Common |
| GND | 3 | Digital ground |
| IN1 | 1 | Digital control to connect COM to NO or NC |
| IN2 | 5 | Digital control to connect COM to NO or NC |
| NC1 | 9 | Normally closed |
| NC2 | 7 | Normally closed |
| NO1 | 2 | Normally open |
| NO2 | 4 | Normally open |
| V $_{+}$ | 8 | Power supply |

PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
| :---: | :---: |
| $\mathrm{V}_{\text {com }}$ | Voltage at COM |
| $\mathrm{V}_{\mathrm{NC}}$ | Voltage at NC |
| $\mathrm{V}_{\mathrm{NO}}$ | Voltage at NO |
| $\mathrm{r}_{\text {on }}$ | Resistance between COM and NC or COM and NO ports when the channel is ON |
| $\Delta r_{0}$ | Difference of $r_{\text {on }}$ between channels |
| $\mathrm{r}_{\text {on(lat) }}$ | Difference between the maximum and minimum value of $r_{\text {on }}$ in a channel over the specified range of conditions |
| $1 \mathrm{NC}($ OFF) | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worstcase input and output conditions |
| $1_{\text {No(OFF) }}$ | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worstcase input and output conditions |
| Inc(ON) | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) being open |
| ${ }^{\text {noo(ON) }}$ | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) being open |
| $\mathrm{ICOMON}^{\text {a }}$ | Leakage current measured at the COM port, with the corresponding channel ( NO to COM or NC to COM) in the ON state and the output (NC or NO) being open |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum input voltage for logic high for the control input (IN) |
| $\mathrm{V}_{\mathrm{LL}}$ | Minimum input voltage for logic low for the control input (IN) |
| $\mathrm{V}_{1 \times}$ | Voltage at IN |
| $\mathrm{I}_{\mathrm{H},} \mathrm{I}_{\mathrm{LL}}$ | Leakage current measured at $\mathbb{N}$ |
| ton | Turnon time for the switch. Measure this parameter under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM/NC/NO) signal when the switch is turning ON. |
| toff | Turnoff time for the switch. Measure this parameter under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM/NC/NO) signal when the switch is turning OFF. |
| $\mathrm{t}_{\text {BBM }}$ | Break-before-make time. Measure this parameter under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state. |
| $\mathrm{Q}_{\mathrm{C}}$ | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This measure is in coulombs ( C ) and is the total charge induced due to switching of the control input. Charge injection, $Q_{C}=C_{L} \times \Delta V_{O}, C_{L}$ is the load capacitance and $\Delta V_{O}$ is the change in analog output voltage. |
| $\mathrm{C}_{\text {NC(OFF) }}$ | Capacitance at the NC port when the corresponding channel (NC to COM) is OFF |
| $\mathrm{C}_{\text {NOOFFF }}$ | Capacitance at the NO port when the corresponding channel (NC to COM) is OFF |
| $\mathrm{C}_{\mathrm{NC} \text { (ON) }}$ | Capacitance at the NC port when the corresponding channel (NC to COM) is ON |
| $\mathrm{C}_{\text {No(ON) }}$ | Capacitance at the NO port when the corresponding channel (NC to COM) is ON |
| ССоm(0N) | Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON |
| $\mathrm{CIN}_{\text {IN }}$ | Capacitance of IN |
| $\mathrm{O}_{13}$ | OFF isolation of the switch is a measurement of OFF-state switch impedance. This measure is in dB at a specific frequency, with the corresponding channel ( NC to COM or NO to COM ) in the OFF state. OFF isolation, $\mathrm{O}_{150}=20 \mathrm{LOG}$ $\left(\mathrm{V}_{\mathrm{NC}} / \mathrm{V}_{\mathrm{COM}}\right) \mathrm{dB}, \mathrm{V}_{\mathrm{COM}}$ is the input and $\mathrm{V}_{\mathrm{NC}}$ is the output. |

## PARAMETER DESCRIPTION (continued)

| SYMBOL | DESCRIPTION |
| :---: | :---: |
| $\mathrm{X}_{\text {TALK }}$ | Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to $\mathrm{NC})$. This measure is at a specific frequency and in dB. Crosstalk, $\mathrm{X}_{\mathrm{TALK}}=20 \log \left(\mathrm{~V}_{\mathrm{NC} 1} / \mathrm{V}_{\mathrm{NO} 1}\right), \mathrm{V}_{\mathrm{NO} 1}$ is the input and $\mathrm{V}_{\mathrm{NC} 1}$ is the output. |
| BW | Bandwidth of the switch. This is the frequency where the gain of an ON channel is -3 dB below the dc gain. Gain is measured from the equation, $20 \log \left(V_{N C} / V_{C O M}\right) d B$, where $V_{N C}$ is the output and $\mathrm{V}_{\mathrm{COM}}$ is the input. |
| $\mathrm{I}_{+}$ | Static power-supply current with the control (IN) pin at $\mathrm{V}_{+}$or GND |
| $\Delta I_{+}$ | This is the increase in $\mathrm{I}_{+}$for each control (IN) input that is at the specified voltage, rather than at $\mathrm{V}_{+}$or GND. |

## PARAMETER MEASUREMENT INFORMATION



$$
\begin{aligned}
& \text { Channel ON } \\
& \mathrm{r}_{\text {on }}=\frac{\mathrm{v}_{\mathrm{COM}}-\mathrm{V}_{\mathrm{NO} / \mathrm{NC}}}{\mathrm{I}_{\mathrm{COM}}} \Omega \\
& \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}}
\end{aligned}
$$

Figure 6. ON-State Resistance ( $\mathbf{R}_{\mathrm{on}}$ )

OFF-State Leakage Current
Channel OFF
$\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$
$\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=0$ to $\mathrm{V}_{+}$ or
$\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$

| ON-State Leakage Current |
| :--- |
| Channel ON |
| $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |
| $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=0$ to $\mathrm{V}_{+}, \mathrm{V}_{\text {COM }}=$ Open |
| or |
| $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=$ Open, $\mathrm{V}_{\text {COM }}=0$ to $\mathrm{V}_{+}$ |

Figure 7. ON- and OFF-State Leakage Current (ICOM(ON), $\left.I_{\mathrm{NC}(\mathrm{OFF})}, I_{\mathrm{NO}(\mathrm{OFF})}, I_{\mathrm{NC}(\mathrm{ON})}, I_{\mathrm{NO}(\mathrm{ON})}\right)$


Figure 8. Capacitance ( $\left.\mathrm{C}_{\mathrm{IN}}, \mathrm{C}_{\mathrm{COM}(\mathrm{ON}),} \mathrm{C}_{\mathrm{NC}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{NO}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{NC}(\mathrm{ON})}, \mathrm{C}_{\mathrm{NO}(\mathrm{ON})}\right)$

## PARAMETER MEASUREMENT INFORMATION (continued)



Figure 9. Turn-On Time ( $\mathrm{t}_{\mathrm{ON}}$ ) and Turn-Off Time ( $\mathrm{t}_{\mathrm{OFF}}$ )


Figure 10. Break-Before-Make Time ( $\mathrm{t}_{\mathrm{BB}}$ )


Figure 11. Frequency Response (BW)

## PARAMETER MEASUREMENT INFORMATION (continued)



> Channel OFF: NC to COM
> OFF Isolation $=20 \log \frac{v_{\text {COM }}}{V_{N C}} d B$

Network Analyzer Setup
Source Power = 0 dBM
DC Bias $=350 \mathrm{mV}$

Figure 12. OFF Isolation ( $\mathrm{O}_{\mathrm{ISO}}$ )


Figure 13. Crosstalk ( $\mathrm{X}_{\text {TALK }}$


Figure 14. Charge Injection $\left(Q_{C}\right)$

## PARAMETER MEASUREMENT INFORMATION (continued)



Figure 15. Total Harmonic Distortion (THD)

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead/Ball Finish <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A23157QDGSRQ1 | ACTIVE | VSSOP | DGS | 10 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | NIPDAU | Level-3-260C-168 HR | -40 to 125 | SJC | Samples |
| TS5A23157TDGSRQ1 | ACTIVE | VSSOP | DGS | 10 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | NIPDAU | Level-3-260C-168 HR | -40 to 105 | JBR | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000$ ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TS5A23157-Q1 :

- Catalog: TS5A23157

NOTE: Qualified Version Definitions:

- Catalog - Tl's standard catalog product


## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A23157QDGSRQ1 | VSSOP | DGS | 10 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| TS5A23157TDGSRQ1 | VSSOP | DGS | 10 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A23157QDGSRQ1 | VSSOP | DGS | 10 | 2500 | 346.0 | 346.0 | 29.0 |
| TS5A23157TDGSRQ1 | VSSOP | DGS | 10 | 2500 | 346.0 | 346.0 | 29.0 |



## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187, variation BA.


NOTES: (continued)
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.


SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL SCALE:10X

NOTES: (continued)
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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